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QFET™

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FQP18N20V2/FQPF18N20V2

200V N-Channel MOSFET

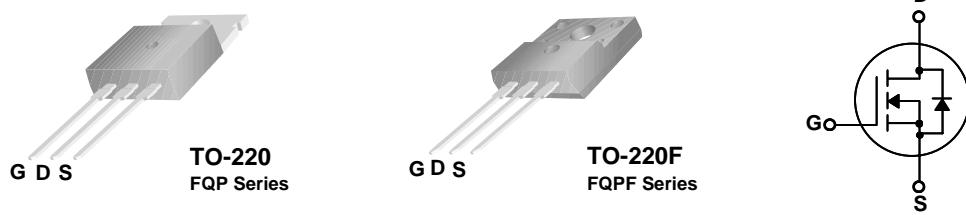
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for low voltage applications such as automotive, high efficiency switching for DC/DC converters, and DC motor control.

Features

- 18A, 200V, $R_{DS(on)} = 0.14\Omega$ @ $V_{GS} = 10$ V
- Low gate charge (typical 20 nC)
- Low C_{RSS} (typical 25 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	FQP18N20V2	FQPF18N20V2	Units
V_{DSS}	Drain-Source Voltage	200		V
I_D	Drain Current - Continuous ($T_C = 25^\circ\text{C}$)	18	18	A
	- Continuous ($T_C = 100^\circ\text{C}$)	11.9	11.9	A
I_{DM}	Drain Current - Pulsed	(Note 1)	72	A
V_{GSS}	Gate-Source Voltage		± 30	V
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	340	mJ
I_{AR}	Avalanche Current	(Note 1)	18	A
E_{AR}	Repetitive Avalanche Energy	(Note 1)	12.3	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.5	V/ns
P_D	Power Dissipation ($T_C = 25^\circ\text{C}$)	123	40	W
	- Derate above 25°C	0.99	0.32	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	$^\circ\text{C}$
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	FQP18N20V2	FQPF18N20V2	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	1.01	3.1	$^\circ\text{C}/\text{W}$
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink	0.5	--	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	$^\circ\text{C}/\text{W}$

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$	200	--	--	V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C	--	0.25	--	$^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 200 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$	--	--	1	μA
		$V_{\text{DS}} = 160 \text{ V}$, $T_C = 125^\circ\text{C}$	--	--	10	μA
I_{GSSF}	Gate-Body Leakage Current, Forward	$V_{\text{GS}} = 30 \text{ V}$, $V_{\text{DS}} = 0 \text{ V}$	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	$V_{\text{GS}} = -30 \text{ V}$, $V_{\text{DS}} = 0 \text{ V}$	--	--	-100	nA
On Characteristics						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$, $I_D = 250 \mu\text{A}$	3.0	--	5.0	V
$R_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 10 \text{ V}$, $I_D = 9 \text{ A}$	--	0.12	0.14	Ω
g_{FS}	Forward Transconductance	$V_{\text{DS}} = 40 \text{ V}$, $I_D = 9 \text{ A}$ (Note 4)	--	11	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}} = 25 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$, $f = 1.0 \text{ MHz}$	--	830	1080	pF
C_{oss}	Output Capacitance		--	200	260	pF
C_{rss}	Reverse Transfer Capacitance		--	25	33	pF
C_{oss}	Output Capacitance	$V_{\text{DS}} = 160 \text{ V}$, $V_{\text{GS}} = 0 \text{ V}$, $f = 1.0 \text{ MHz}$	--	70	--	pF
$C_{\text{oss eff.}}$	Effective Output Capacitance	$V_{\text{DS}} = 0 \text{ V}$ to 160 V , $V_{\text{GS}} = 0 \text{ V}$	--	135	--	pF
Switching Characteristics						
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}} = 100 \text{ V}$, $I_D = 18 \text{ A}$, $R_G = 25 \Omega$ (Note 4, 5)	--	16	40	ns
t_r	Turn-On Rise Time		--	133	275	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	38	85	ns
t_f	Turn-Off Fall Time		--	62	135	ns
Q_g	Total Gate Charge	$V_{\text{DS}} = 160 \text{ V}$, $I_D = 18 \text{ A}$, $V_{\text{GS}} = 10 \text{ V}$ (Note 4, 5)	--	20	26	nC
Q_{gs}	Gate-Source Charge		--	5.6	--	nC
Q_{gd}	Gate-Drain Charge		--	10	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current	--	--	18	--	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current	--	--	72	--	A
V_{SD}	Drain-Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}$, $I_S = 18 \text{ A}$	--	--	1.5	V
t_{rr}	Reverse Recovery Time	$V_{\text{GS}} = 0 \text{ V}$, $I_S = 18 \text{ A}$, $dI_F / dt = 100 \text{ A}/\mu\text{s}$ (Note 4)	--	158	--	ns
Q_{rr}	Reverse Recovery Charge		--	1.0	--	μC

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. $L = 1.58\text{mH}$, $I_{AS} = 18\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25 \Omega$, Starting $T_J = 25^\circ\text{C}$
3. $I_{SD} \leq 18\text{A}$, $dI/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq \text{BV}_{\text{DSS}}$, Starting $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$
5. Essentially independent of operating temperature

Typical Characteristics

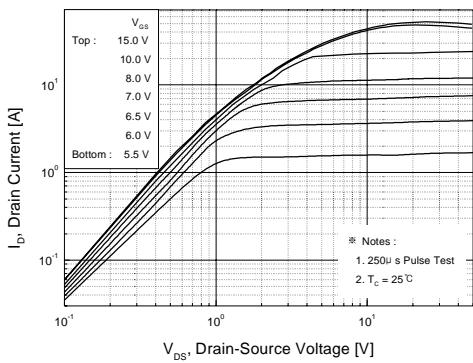


Figure 1. On-Region Characteristics

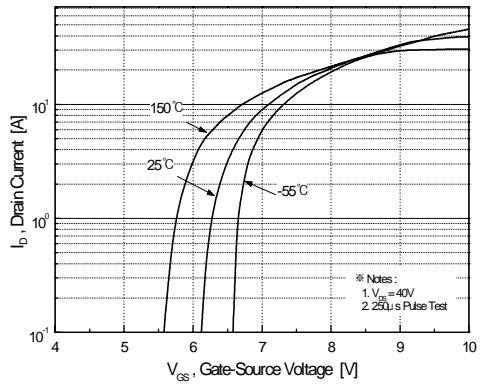


Figure 2. Transfer Characteristics

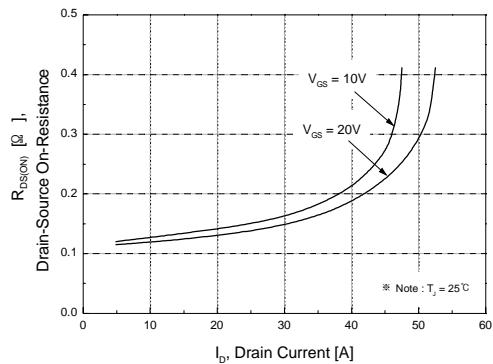


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

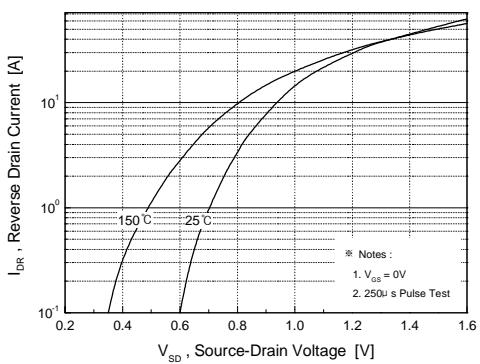


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

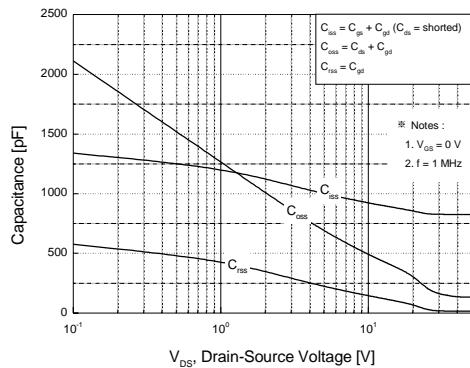


Figure 5. Capacitance Characteristics

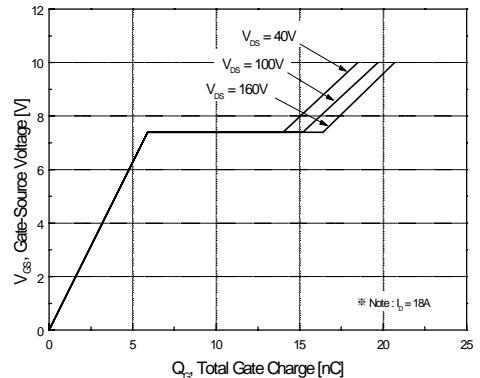


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

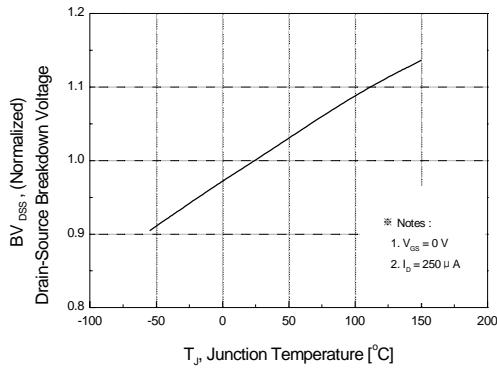


Figure 7. Breakdown Voltage Variation vs. Temperature

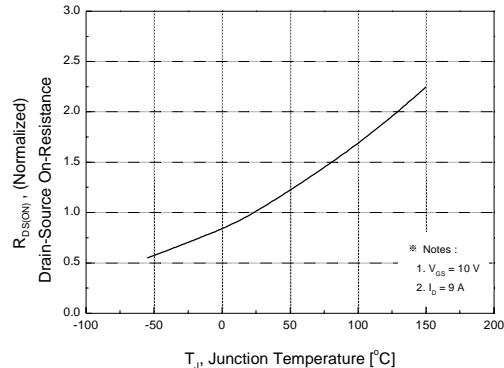


Figure 8. On-Resistance Variation

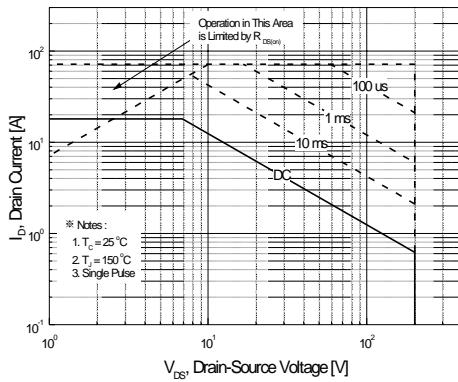


Figure 9-1. Maximum Safe Operating Area for FQP18N20V2

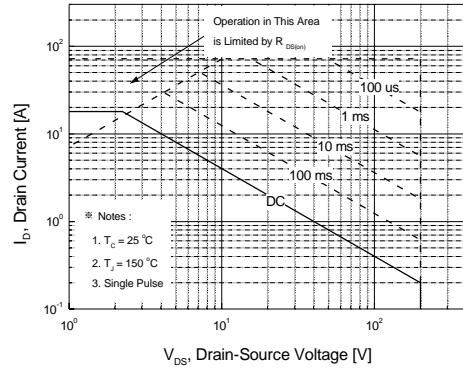


Figure 9-2. Maximum Safe Operating Area for FQPF18N20V2

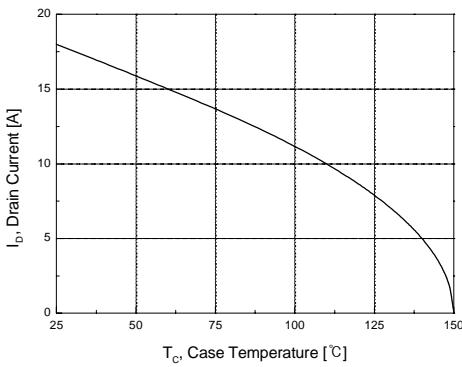


Figure 10. Maximum Drain Current vs. Case Temperature

Typical Characteristics (Continued)

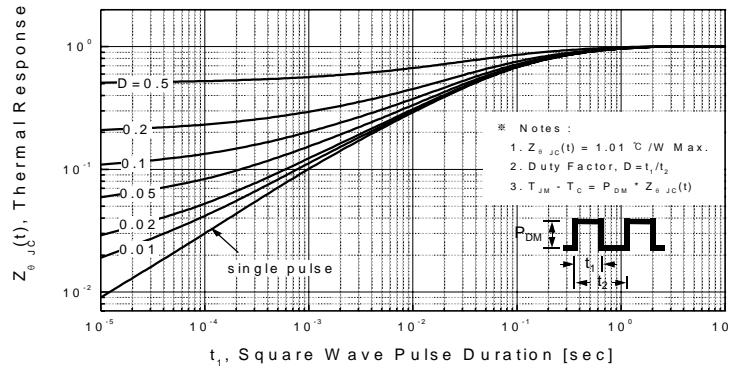


Figure 11-1. Transient Thermal Response Curve for FQP18N20V2

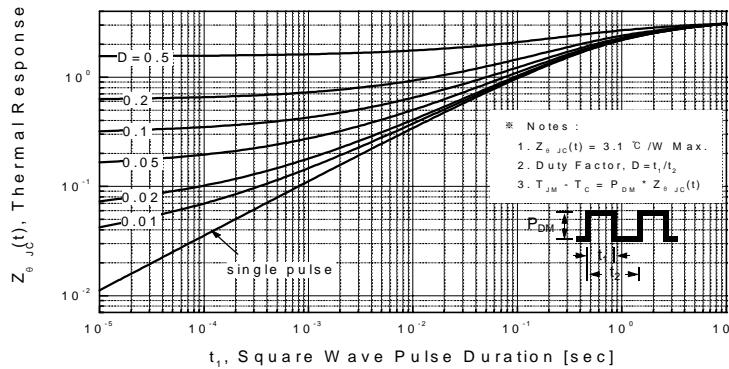
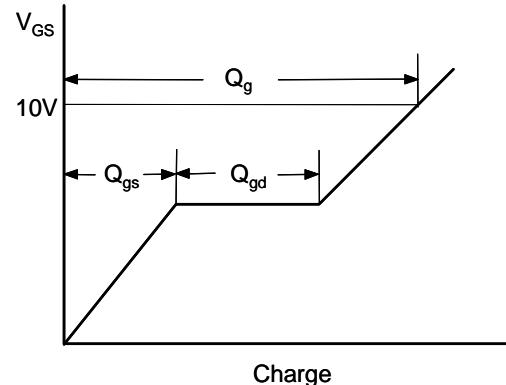
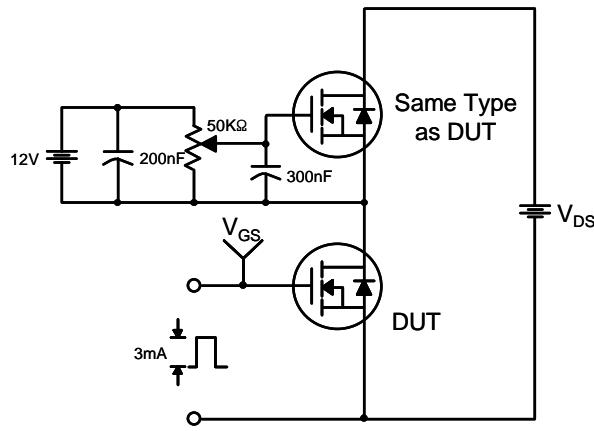
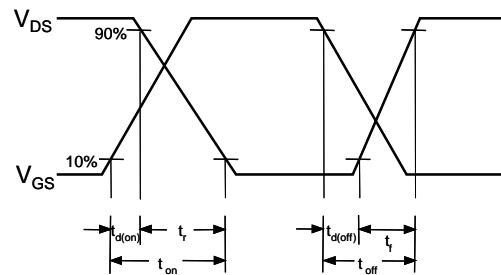
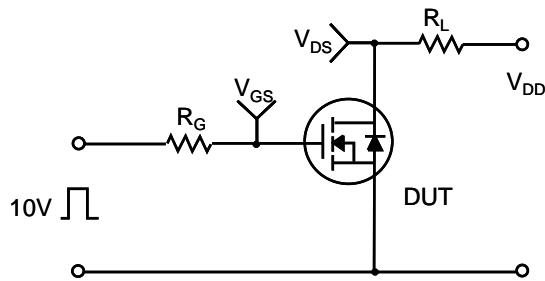


Figure 11-2. Transient Thermal Response Curve for FQPF18N20V2

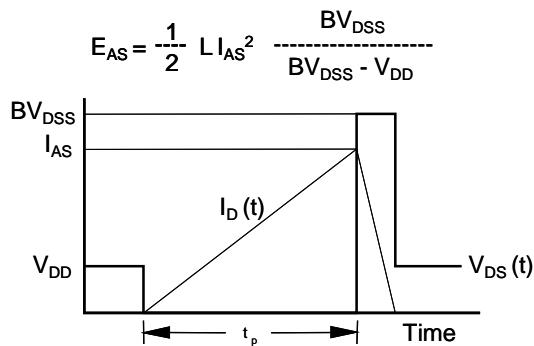
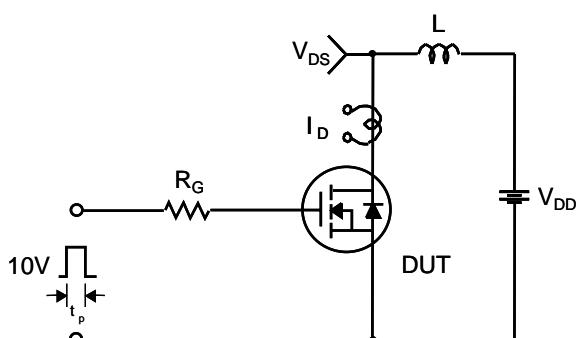
Gate Charge Test Circuit & Waveform



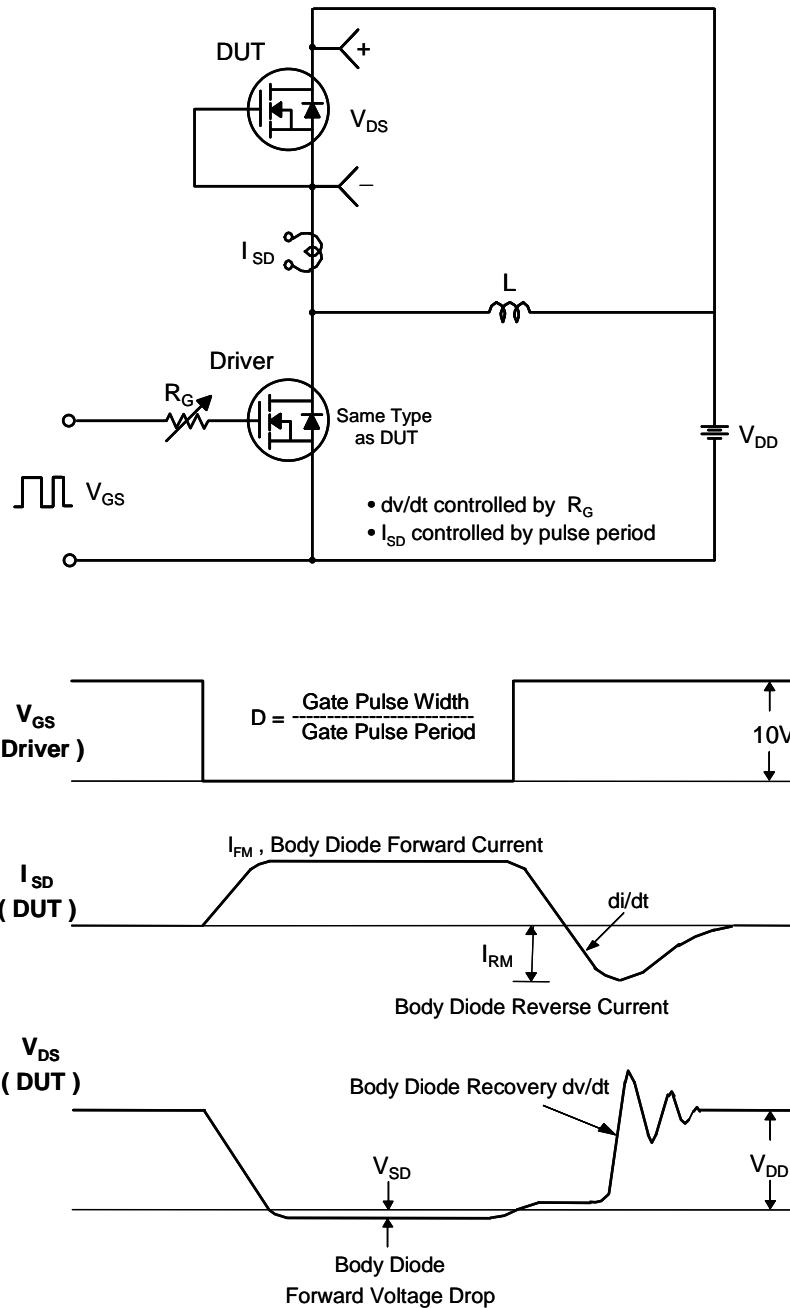
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

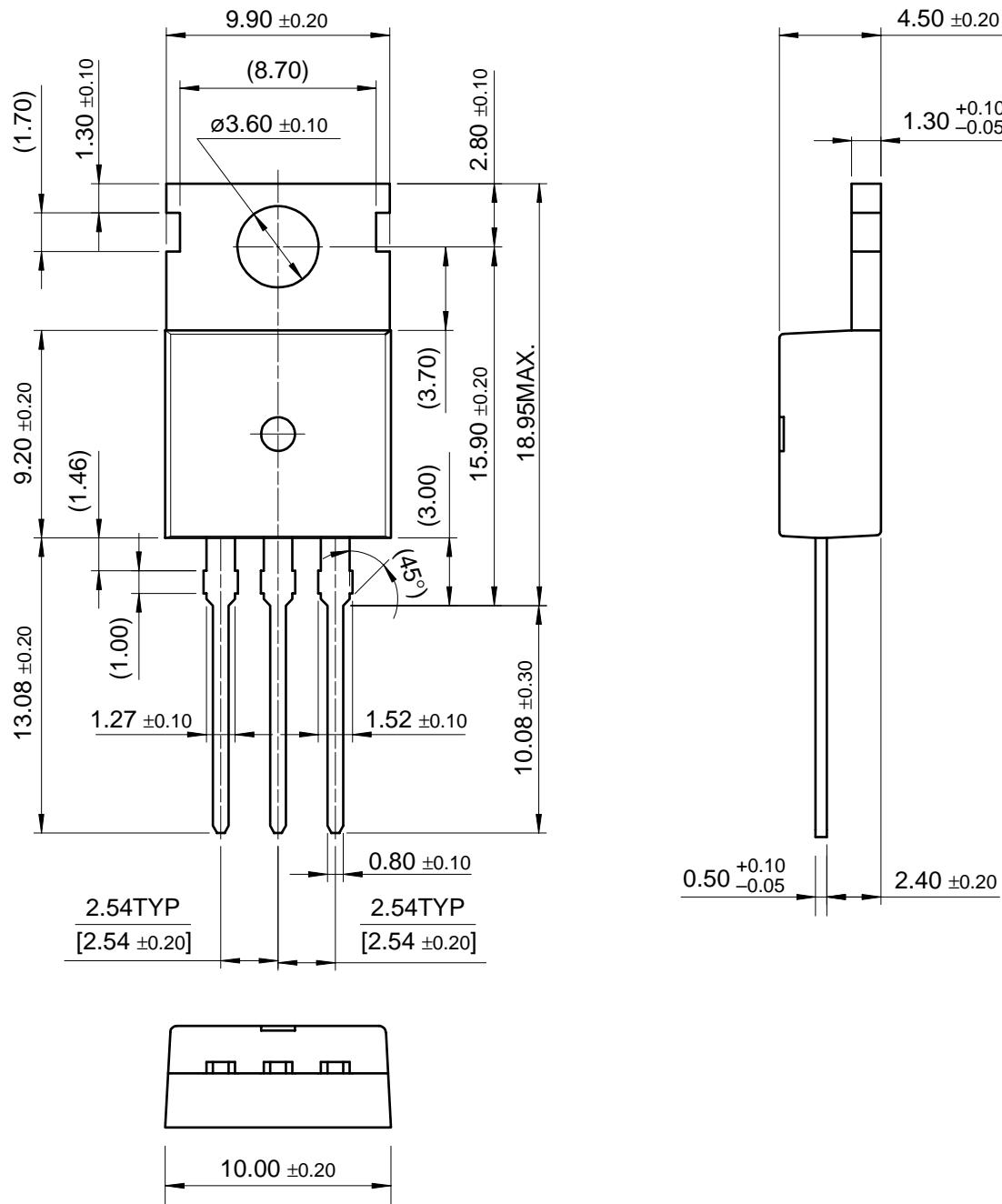


Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimensions

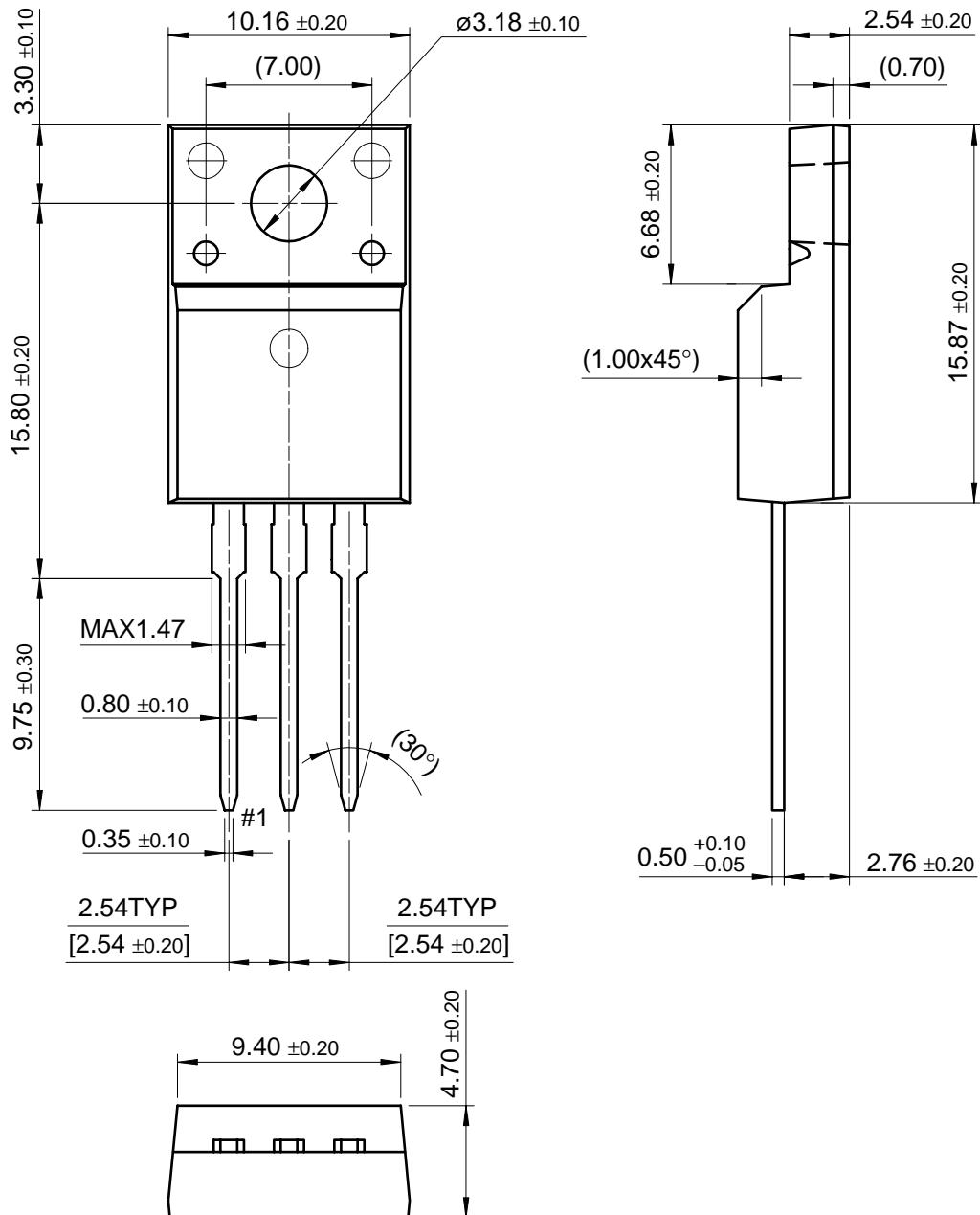
TO-220



Dimensions in Millimeters

Package Dimensions (Continued)

TO-220F



Dimensions in Millimeters

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